S & M 1663

Description of New Piezoresistance Tensor Equation for Cubic Single Crystal and Its Application to Multiaxial Stress

Taeko Ando^{*} and Toshiyuki Toriyama

Department of Mechanical Engineering, College of Science and Engineering Ritsumeikan University, 1-1-1 Noji-higashi, Kusatsu, Shiga 525-8577, Japan

(Received April 6, 2018; accepted August 6, 2018)

Keywords: piezoresistance, cubic single crystal, multiaxial stress, tensor equation

In this paper, we derived a new piezoresistance tensor equation for a cubic single crystal. This equation can be expressed in terms of the three independent principal components of piezoresistance tensors, the isotropic and deviatoric stress tensors, and the fourth-rank coordinate transformation tensor. The piezoresistance tensor equation can be decomposed into a relation between only the hydrostatic part of the stress tensor and the trace of the resistivity change tensor and into a relation between only the deviatoric parts. The hydrostatic part of the piezoresistance tensor equation is invariant with respect to a coordinate transformation. On the other hand, the deviatoric part of the tensor equation is traceless. The proposed piezoresistance tensor decomposition gives a new physical insight into the classical theory of Pfann and Thurston [J. Appl. Phys. **32** (2008) 1961]. It was shown that Pfann and Thurston's theory can be rewritten as a special case of our tensor decomposition. Furthermore, to demonstrate the consistency between the proposed tensor equation and the experimental evidence, some basic experiments on a single-crystal silicon piezoresistive rosette stress gauge subjected to multiaxial stress were carried out.

1. Introduction

The piezoresistance in various types of cubic single crystals is widely used as a forcesensing element in micro-electromechanical systems (MEMS).^(1–5) The large piezoresistance in single-crystal silicon was discovered by Smith in 1954,⁽⁶⁾ who described some of the basic properties of the piezoresistance from the viewpoint of the fourth-rank tensor field.⁽⁷⁾ In the same era, Pfann and Thurston proposed a theory of single-crystal silicon piezoresistive stress transducers considering the anisotropy of cubic crystals.⁽⁸⁾ Tufte and Stelzer performed important experiments on a heavily doped single-crystal silicon piezoresistive stress gauge produced with an integrated circuit (IC)-compatible fabrication process.^(9,10) Their results have been widely used as a design standard for single-crystal silicon piezoresistive stress transducers on IC chips. Since then, the number of published papers concerning cubic-single-crystal piezoresistive stress transducers has increased yearly.^(1–5) The successful launch of cubic-

*Corresponding author: e-mail: tando@fc.ritsumei.ac.jp https://doi.org/10.18494/SAM.2018.1959 single-crystal piezoresistive stress transducers into the MEMS market is due to the huge amount of accumulated data and the IC-compatible microfabrication process. An excellent review by Barlian *et al.* described the research trend of applying cubic-single-crystal semiconductor piezoresistance to microsystem technology over half a century.⁽³⁾

The classical theory of Pfann and Thurston has been widely supported by practical engineers designing cubic-single-crystal piezoresistive stress transducers.⁽³⁾ Pfann and Thurston adopted the Voigt notation to describe the components of the cubic piezoresistance tensor. They derived 21 components of the piezoresistance tensor in terms of three independent principal components and the direction cosine between the principal crystallographic orientation and an arbitrary crystallographic orientation. The combination of the 21 components of the piezoresistance tensor and the six components of the stress tensor leads to six piezoresistance equations containing the state of multiaxial stress and an arbitrary crystallographic orientation. However, the obtained mathematical structure of the piezoresistance is very complex and it is difficult to find the general physical role of the state of multiaxial stress in the cubic crystal anisotropy of the piezoresistance. A plausible reason for the lack of physical significance of Pfann and Thurston's theory is the adoption of components in the analysis of piezoresistance. It is well recognized that the analysis of piezoresistance based on its components and coefficients is very useful for specific engineering designs and applications, such as specific stress states, crystallographic planes, and orientations in advance. However, the analysis of piezoresistance in terms of its components gives an unclear physical relationship between the state of multiaxial stress and the crystal anisotropy of the piezoresistance with respect to a coordinate transformation.

Therefore, in this paper, we derive a single piezoresistance tensor equation that clearly indicates the physical role of the state of multiaxial stress in the cubic crystal anisotropy of the piezoresistance. Both the fourth-rank piezoresistance tensor and the second-rank stress tensor are decomposed into isotropic (hydrostatic) and deviatoric parts. Then, the piezoresistance tensor equation is decomposed into isotropic and deviatoric parts. The piezoresistance tensor equation can also be decomposed into a relation between only the hydrostatic part of the stress tensor and the trace of the resistivity change tensor and another relation between only the deviatoric parts. The hydrostatic part of the piezoresistance tensor equation is invariant with respect to a coordinate transformation. On the other hand, the deviatoric part of the tensor equation is traceless. These are new findings in the theory of piezoresistance. The piezoresistance tensor equation gives a new physical insight into the typical single-crystal silicon piezoresistive stress transducers derived by Pfann and Thurston.⁽⁸⁾ It was shown that Pfann and Thurston's theory can be rewritten as a special case of our tensor decomposition. The cubic-single-crystal piezoresistance may be regarded as a revisited problem,⁽⁷⁻¹⁰⁾ but our sophisticated method gives a new physical insight into the theory of cubic crystal piezoresistance and into practical design applications, as briefly demonstrated in the appropriate sections in this paper. Furthermore, to demonstrate the consistency between the tensor equation and the experimental evidence, some basic experiments on a single-crystal silicon piezoresistive stress gauge subjected to multiaxial stress were carried out.

The organization of our paper is as follows. In the first part of this paper, we derive a single piezoresistance tensor equation. It is shown that this equation can be expressed in terms of the three independent principal components of piezoresistance tensors, the isotropic (hydrostatic) and deviatoric stress tensors, and the fourth-rank coordinate transformation tensor. In addition, the physical structure of the cubic piezoresistance subjected to an arbitrary plane stress is clarified under a coordinate transformation. The obtained result will be useful for MEMS piezoresistive mechanical sensor design because a single-crystal silicon wafer is the standard substrate for the fabrication process and the MEMS piezoresistive mechanical sensor is subjected to a plane stress condition in most applications.

In the second part of this paper, the piezoresistance measurement of a single-crystal silicon microbeam element subjected to multiaxial stress is carried out. The microfabrication process and experimental procedure for the single-crystal silicon piezoresistive multiaxial stress rosette gauge on the microbeam element are briefly described. To demonstrate the mathematical and physical validity of the proposed concept, experimental results are compared with a theoretical prediction based on the tensor equation. It is shown that the decomposition of the piezoresistance tensor can give new physical insight into the classical theory of Pfann and Thurston (hereafter referred to as the PT theory). The basic concept of the PT theory is to form a piezoresistor that responds only to specified stress components. Regarding this point, the PT theory provides no physical basis to find a combination of appropriate crystallographic orientations that exhibits sensitivity to the specified stress components. It is demonstrated that making a piezoresistor unresponsive to specified stress components is equivalent to finding an appropriate form of the deviatoric part of the piezoresistance tensor equation that can cancel the specified stress components appearing in the hydrostatic part of it.

2. Description of Piezoresistance Tensor Equation for Cubic-Single-Crystal Symmetry

2.1 Piezoresistance tensor equation for cubic-crystal symmetry

We define two Cartesian coordinate systems corresponding to the arbitrary crystallographic frame $O-x_1x_2x_3$ and the principal cubic-single-crystal crystallographic frame $O-X_1X_2X_3$. The orthogonal orientations of the two Cartesian coordinate systems can be related by three Euler angles (ψ , θ , ϕ). If an index occurs twice in any term of the Cartesian tensor components, summation is taken from 1 to 3. However, the tensor summation convention does not apply to the Greek indices. Furthermore, the capital letters in the summation symbol obey the ordinary summation rule and the tensor summation convention does not apply to them. According to a previous work,⁽¹¹⁾ a piezoresistance tensor having cubic anisotropy with respect to the cubicsingle-crystal crystallographic principal frame $O-X_1X_2X_3$ can be written as

$$\Pi_{ijkl} = \hat{\Pi}_1 \delta_{ij} \delta_{kl} + 2\hat{\Pi}_2 I_{ijkl} + \hat{\Pi}_3 \sum_{L=1}^3 \delta_{iL} \delta_{jL} \delta_{kL} \delta_{lL}, \qquad (1)$$

where δ_{ij} is the Kronecker delta, $I_{ijkl} = \frac{1}{2} \left(\delta_{ik} \delta_{jl} + \delta_{il} \delta_{jk} \right)$,

$$\hat{\Pi}_{1} = \Pi_{1122} = \Pi_{2211} = \Pi_{2233} = \Pi_{3322} = \Pi_{3311} = \Pi_{1133},$$

$$\hat{\Pi}_{2} = \Pi_{2323} = \Pi_{3131} = \Pi_{1212}$$

$$(\Pi_{2323} = \Pi_{2332} = \Pi_{3223} = \Pi_{3232}, \text{ and similarly for other components, } \Pi_{3131} \text{ and } \Pi_{1212},$$

$$\hat{\Pi}_{1} + 2\hat{\Pi}_{2} + \hat{\Pi}_{3} = \Pi_{1111} = \Pi_{2222} = \Pi_{3333}.$$

Note that the anisotropy factors defined as $\hat{\Pi}_1$, $\hat{\Pi}_2$, and $\hat{\Pi}_3$ are measures of the anisotropy of crystals, and these are standard descriptions for the elastic compliance and stiffness tensors. The Voigt notation reduces the fourth-rank tensor components to second-rank components as $\Pi_{1111} = \Pi_{11}$, $\Pi_{1122} = \Pi_{12}$, and $\Pi_{2323} = \frac{\Pi_{44}}{2}$. The law of the fourth-rank tensor transformation leads to the following piezoresistance tensor with respect to the arbitrary crystallographic frame:

$$\pi_{ijkl} = \prod_{pqrs} \frac{\partial X_p}{\partial x_i} \frac{\partial X_q}{\partial x_i} \frac{\partial X_r}{\partial x_k} \frac{\partial X_s}{\partial x_l}, \qquad (2)$$

where $\frac{\partial X_p}{\partial x_i}$ is the direction cosine between the reference frames O- $X_1X_2X_3$ and O- $x_1x_2x_3$, which can be expressed by a standard method using the three Euler angles (ψ , θ , ϕ) (Fig. 1) as follows.⁽¹²⁾



Fig. 1. (Color online) Three Euler angles (ψ, θ, ϕ) used to define the direction cosine tensor component $\frac{\partial X_p}{\partial x_i}$ between the piezoresistor reference frame O- $X_1X_2X_3$ and the crystallographic principal frame O- $x_1x_2x_3$.

$$X_{1} \qquad X_{2} \qquad X_{3}$$

$$X_{1} = \cos\phi\cos\theta\cos\psi \qquad a_{12} = \cos\phi\cos\theta\sin\psi \qquad a_{13} = -\cos\phi\sin\theta \qquad x_{3}$$

$$X_{1} \qquad -\sin\phi\sin\psi \qquad +\sin\phi\cos\psi \qquad a_{13} = -\cos\phi\sin\theta \qquad x_{3}$$

$$X_{2} \qquad a_{21} = -\sin\phi\cos\theta\cos\psi \qquad a_{22} = -\sin\phi\cos\theta\sin\psi \qquad a_{23} = \sin\phi\sin\theta \qquad (3)$$

$$X_{3} \qquad a_{31} = \sin\theta\cos\psi \qquad a_{32} = \sin\theta\sin\psi \qquad a_{33} = \cos\theta$$

The substitution of Eq. (1) into Eq. (2) leads to the following piezoresistance tensor with respect to the arbitrary crystallographic frame $O-x_1x_2x_3$:

$$\pi_{ijkl} = \hat{\Pi}_1 \delta_{ij} \delta_{kl} + 2 \hat{\Pi}_2 I_{ijkl} + \hat{\Pi}_3 L_{ijkl} \,, \tag{4}$$

where $L_{ijkl} \equiv \sum_{L=1}^{3} a_{Li} a_{Lj} a_{Lk} a_{Ll}$ is a fourth-rank tensor that consists of the second-rank tensors

 $a_{Li} \equiv \frac{\partial X_L}{\partial x_i}$ given in Eq. (3). The fourth-rank tensor L_{ijkl} can be decomposed into isotropic and deviatoric parts as (see Appendix A)

$$L_{ijkl} = \left(L_{ijkl}\right)_{isotropic} + \left(L_{ijkl}\right)_{deviatoric} \equiv \left(L_{ijkl}\right)_{I} + \left(L_{ijkl}\right)^{*}, \tag{5}$$

where

$$(L_{ijkl})_{isotropic} \equiv (L_{ijkl})_{I} = L_{1}\delta_{ij}\delta_{kl} + 2L_{2}I_{ijkl} = \frac{1}{5}(\delta_{ij}\delta_{kl} + 2I_{ijkl}),$$

$$L_{1} = \frac{1}{15}(2L_{ppqq} - L_{pqpq}) = \frac{1}{5}, \text{ and } L_{2} = \frac{1}{10}(L_{pqpq} - \frac{1}{3}L_{ppqq}) = \frac{1}{5}.$$

The piezoresistance tensor π_{ijkl} can be decomposed into isotropic and deviatoric parts in a similar way to Eq. (5) (see Appendix A):

$$\pi_{ijkl} = \left(\pi_{ijkl}\right)_{isotropic} + \left(\pi_{ijkl}\right)_{deviatoric} \equiv \left(\pi_{ijkl}\right)_{I} + \left(\pi_{ijkl}\right)^{*},\tag{6}$$

where

$$(\pi_{ijkl})_{isotropic} = (\pi_{ijkl})_I = (\hat{\Pi}_1 + \frac{1}{5}\hat{\Pi}_3)\delta_{ij}\delta_{kl} + 2(\hat{\Pi}_2 + \frac{1}{5}\hat{\Pi}_3)I_{ijkl},$$
$$(\pi_{ijkl})_{deviatoric} = (\pi_{ijkl})^* = \hat{\Pi}_3 \left[L_{ijkl} - \frac{1}{5} (\delta_{ij}\delta_{kl} + 2I_{ijkl}) \right].$$

The stress tensor can be decomposed into isotropic (spherical) and deviatoric parts by referring to the classical continuum theory of plasticity as follows:⁽¹³⁾

$$\sigma_{ij} = \left(\sigma_{ij}\right)_{isotropic} + \left(\sigma_{ij}\right)_{deviatoric} \equiv \sigma \delta_{ij} + \left(\sigma_{ij}\right)^{*},\tag{7}$$

where $\sigma = \frac{1}{3}\sigma_{pp}$ is the scalar-valued mean stress related to the first stress invariant, and $(\sigma_{ij})^*$

is the deviatoric stress tensor whose trace is $(\sigma_{pp})^* = 0$.

The generalized Ohm's law with respect to the arbitrary crystallographic frame $O-x_1x_2x_3$ is expressed as⁽⁷⁾

$$\boldsymbol{e}_{i} = \left(\rho_{0}\delta_{ik} + \Delta\rho_{ik}\right)\boldsymbol{j}_{k}, \qquad (8)$$

where e_i is the electrical field vector, j_k is the current density vector, ρ_0 is the scalar invariant of the zero-stress resistivity, and $\Delta \rho_{ik}$ is the resistivity change tensor due to the applied stress. When stress is applied to a cubic anisotropic medium with respect to the arbitrary crystallographic frame O- $x_1x_2x_3$, the second-rank tensor fields of stress and resistivity change are connected at every point by the linear relation^(3,6)

$$\frac{\Delta \rho_{ij}}{\rho_0} = \pi_{ijkl} \sigma_{kl},\tag{9}$$

where $\frac{\Delta \rho_{ij}}{\rho_0}$ is the relative resistivity change tensor due to the applied stress.

The substitution of Eqs. (6) and (7) into Eq. (9) leads to the decomposition of the piezoresistance tensor equation into the hydrostatic and deviatoric parts of stress tensors,

$$\frac{\Delta \rho_{ij}}{\rho_0} = \frac{1}{3} \frac{\Delta \rho_{mm}}{\rho_0} \delta_{ij} + \left(\frac{\Delta \rho_{ij}}{\rho_0}\right)^* \\
= \left(3\hat{\Pi}_1 + 2\hat{\Pi}_2 + \hat{\Pi}_3\right) \sigma \delta_{ij} + 2\hat{\Pi}_2 \left(\sigma_{ij}\right)^* + \hat{\Pi}_3 L_{ijkl} \left(\sigma_{kl}\right)^* \\
= \left(\Pi_{11} + 2\Pi_{12}\right) \sigma \delta_{ij} + \Pi_{44} \left(\sigma_{ij}\right)^* + \left(\Pi_{11} - \Pi_{12} - \Pi_{44}\right) L_{ijkl} \left(\sigma_{kl}\right)^*,$$
(10)

where $\frac{1}{3} \frac{\Delta \rho_{mm}}{\rho_0} \delta_{ij} \equiv (3\hat{\Pi}_1 + 2\hat{\Pi}_2 + \hat{\Pi}_3) \sigma \delta_{ij}$ is the hydrostatic part and $\left(\frac{\Delta \rho_{ij}}{\rho_0}\right)^* \equiv 2\hat{\Pi}_2 (\sigma_{ij})^* + \hat{\Pi}_3 L_{ijkl} (\sigma_{kl})^*$ is the deviatoric part.

An alternative derivation of Eq. (10) is useful to clarify its physical meaning. Therefore, we give a brief discussion below. We note again that if an index occurs once in any term of the Cartesian tensor components, the index is free and is taken from 1 to 3, and if an index occurs twice in any term of the Cartesian tensor components, the index is dummy and summation is taken from 1 to 3. A scalar multiple of π_{mmnn} and δ_{ij} forms the isotropic second-rank piezoresistance tensor $\pi_{ijmm} = \frac{1}{3}\pi_{mmnn}\delta_{ij}$. The fourth-rank piezoresistance tensor π_{ijkl} that becomes the zero second-rank tensor when its suffixes are contracted, i.e., $\pi_{mmkl} = \pi_{klmm} = 0$, is defined as the traceless fourth-rank piezoresistance tensor (deviatoric tensor) $(\pi_{ijkl})^*$. Consequently, the number of independent components is no more than 15 for the symmetric fourth-rank tensor, i.e., $\pi_{ijkl} = \pi_{klij}$. The decomposition of the fourth-rank piezoresistance tensor π_{ijkl} is straightforward,

$$\pi_{ijkl} = \frac{1}{9} \pi_{mmnn} \delta_{ij} \delta_{kl} + \left(\pi_{ijkl}\right)^*, \tag{11}$$

where $(\pi_{mmkl})^* = (\pi_{klmm})^* = 0.$

By introducing the traceless parts of the stress and resistivity change tensors, i.e., $(\sigma_{ij})^* = \sigma_{ij} - \frac{1}{3}\sigma_{pp}\delta_{ij}$ and $(\Delta \rho_{ij})^* = \rho_{ij} - \frac{1}{3}\rho_{pp}\delta_{ij}$, Eq. (9) can be broken down as

$$\frac{1}{3} \frac{\Delta \rho_{pp}}{\rho_0} \delta_{ij} = \frac{1}{3} \pi_{mmnn} \sigma_{pp} \delta_{ij},$$

$$\left(\frac{\Delta \rho_{ij}}{\rho_0}\right)^* = \left(\pi_{ijkl}\right)^* \left(\sigma_{kl}\right)^*.$$
(12)

Therefore, the piezoresistance tensor equation can be decomposed into a relation between only the hydrostatic part of the stress tensor (the trace of the stress tensor) and the trace of the resistivity change tensor and into another relation between only the deviatoric parts. The tensor Eqs. (10) and (12) have clear physical meanings. The deviatoric part of Eqs. (10) and (12) becomes the zero second-rank tensor when its suffixes are contracted, i.e., $2\hat{\Pi}_2(\sigma_{mm})^* + \hat{\Pi}_3 L_{mmkl}(\sigma_{kl})^* = (2\hat{\Pi}_2 + \hat{\Pi}_3)(\sigma_{mm})^* = 0$ and $(\pi_{mmkl})^*(\sigma_{kl})^* = 0$. On the other hand, the isotropic parts of Eqs. (10) and (12) represent the relation between only the hydrostatic part of the stress tensor and the trace of the resistivity change tensor. Therefore, the trace of Eqs. (10) and (12) leads to the following scalar invariant with respect to the coordinate transformation.

$$\frac{\Delta\rho_{mm}}{\rho_0} = \left(\Pi_{11} + 2\Pi_{12}\right)\sigma_{mm} \tag{13}$$

The geometrical explanation of Eq. (13) has not been well recognized. The relative change in resistance in a series-connected configuration of three orthogonal piezoresistors is proportional to the hydrostatic part of the stress tensor and insensitive to the three principal stress orientations as shown in Fig. 2.

If a multiaxial stress is applied to a cubic anisotropic medium with respect to the cubicsingle-crystal crystallographic principal frame $O-X_1X_2X_3$, then the component of the deviatoric stress tensor with respect to the arbitrary crystallographic frame $O-x_1x_2x_3$ is transformed as

$$\left(\sigma'_{ij}\right)^* = a_{ki}a_{lj}\left(\sigma_{kl}\right)^*.$$
(14)

The combination of Eqs. (10) and (14) leads to the following component of the piezoresistance tensor equation with respect to the arbitrary crystallographic frame $O-x_1x_2x_3$ as a function of the stress components with respect to the cubic-single-crystal crystallographic principal frame $O-X_1X_2X_3$:

$$\frac{\Delta \rho_{ij}'}{\rho_0} = \left(3\hat{\Pi}_1 + 2\hat{\Pi}_2 + \hat{\Pi}_3\right)\sigma\delta_{ij} + 2\hat{\Pi}_2 a_{ki}a_{lj}\left(\sigma_{kl}\right)^* + \hat{\Pi}_3\sum_{L=1}^3 a_{Li}a_{Lj}\left(\sigma_{LL}\right)^*
= \left(\Pi_{11} + 2\Pi_{12}\right)\sigma\delta_{ij} + \Pi_{44}a_{ki}a_{lj}\left(\sigma_{kl}\right)^* + \left(\Pi_{11} - \Pi_{12} - \Pi_{44}\right)\sum_{L=1}^3 a_{Li}a_{Lj}\left(\sigma_{LL}\right)^*.$$
(15)

A piezoresistor subjected to a remote uniform uniaxial normal stress along the principal cubicsingle-crystal crystallographic frame is transformed to the state of multiaxial stress by the



Fig. 2. Schematic of the series-connected three-orthogonal-piezoresistor (the relative change in resistance is proportional to the trace of the stress tensor and insensitive to the three principal stress orientations).

coordinate transformation and vice versa. Therefore, such a consideration is useful for the design of MEMS piezoresistive mechanical sensors on single-crystal silicon wafers subjected to arbitrary plane stress. As a special case, if we consider the in-plane (X_1X_2 -plane) state of multiaxial stress with respect to the principal cubic-single-crystal crystallographic frame O- $X_1X_2X_3$, then the relative resistance change $\frac{\Delta R'_{11}}{R_0}$ in a piezoresistor in which the current density and electrical field are both parallel to an arbitrary x'_1 direction on the crystallographic plane (X_1X_2 -plane) can be given by Eqs. (10) and (15), neglecting the dimensional change due to the elastic deformation [this will be briefly discussed as Eq. (17) in Sect. 2.2].

$$\frac{\Delta R_{11}'}{R_0} = \left(\frac{\Delta R_{11}'}{R_0}\right)_{hydrostatic} + \left(\frac{\Delta R_{11}'}{R_0}\right)_{deviatoric}$$

where

$$\left(\frac{\Delta R_{11}'}{R_0}\right)_{hydrostatic} \approx \frac{1}{3} \frac{\Delta \rho_{11}}{\rho_0} \delta_{11} = \frac{1}{3} (\Pi_{11} + 2\Pi_{12}) (\sigma_{11} + \sigma_{22}),$$

$$\left(\frac{\Delta R_{11}'}{R_0}\right)_{deviatoric} \approx \left(\frac{\Delta \rho_{11}}{\rho_0}\right)^* \qquad (16)$$

$$= -\frac{1}{3} (\Pi_{11} - \Pi_{12}) (a_{11}^2 + a_{21}^2) (\sigma_{11} + \sigma_{22}) + (\Pi_{11} - \Pi_{12}) (a_{11}^2 \sigma_{11} + a_{21}^2 \sigma_{22}) + 2\Pi_{44} a_{11} a_{21} \sigma_{12}.$$

These results are used for the discussion of piezoresistance measurement.

2.2 Geometrical effect of resistance change due to linear elastic deformation

We derive a general equation for the effect of the relative resistance change due to elastic deformation. This correction was first discussed by Smith.⁽⁶⁾ We derive the following general tensor equation valid for an arbitrary crystallographic coordinate transformation:

$$\frac{\Delta R_{ij}}{R_0} = \frac{\Delta \rho_{ij}}{\rho_0} + 2\varepsilon_{ij} - \varepsilon_{pp}, \qquad (17)$$

where ε_{ij} is the linear elastic strain tensor and ε_{pp} is the trace of ε_{ij} with reference to the dilatation of normal strain. Equation (17) is only valid for the normal strain (i = j) because the shear strain ($i \neq j$) does not change the volume of a solid and makes no contribution to the resistance change due to elastic deformation.

The linear elastic strain tensor is related to the stress tensor by Hooke's law:

$$\varepsilon_{ij} = s_{ijkl}\sigma_{kl},\tag{18}$$

where s_{ijkl} is the elastic compliance tensor.

The crystal symmetry of the cubic elastic compliance tensor is similar to that of the piezoresistance tensor. Therefore, applying Nye's expression to the Voigt notation,^(14,15) we can derive

$$s_{ijkl} = \hat{S}_1 \delta_{ij} \delta_{kl} + 2\hat{S}_2 I_{ijkl} + \hat{S}_3 L_{ijkl},$$
(19)

where $3\hat{S}_1 + 2\hat{S}_2 + \hat{S}_3 \equiv S_{11} + 2S_{12}, \ 2\hat{S}_2 \equiv \frac{1}{2}S_{44}, \ 2\hat{S}_2 + \hat{S}_3 \equiv S_{11} - S_{12}.$

The substitution of Eqs. (18) and (19) into Eq. (17) leads to the following relative resistance change due to the applied stress in place of the elastic strain:

$$2\varepsilon_{ij} - \varepsilon_{pp} = (S_{11} + 2S_{12})(2\delta_{ij} - 3)\sigma + S_{44}(\sigma_{ij})^* + 2\left(S_{11} - S_{12} - \frac{1}{2}S_{44}\right)L_{ijkl}\sigma_{kl}^*,$$
(20)

where i = j.

Figure 3 depicts graphical representations of $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11}$ for single-crystal silicon subjected to the in-plane uniaxial tension σ_{11} with respect to the arbitrary crystallographic orientation in the {100}, {110}, and {111} planes. The values of the three components of the cubic elastic compliance tensor, i.e., S_{11} , S_{12} , and S_{44} , were taken from Ref. 15 and used for the calculation of $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11}$ from Eq. (20). As can be seen from the figures, it is straightforward to derive Smith's geometrical correction as a special case of Eq. (20). The graphical variation of $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11}$ depicted in Fig. 3 is similar to that of the Young's modulus ⁽¹⁵⁾ because the in-plane uniaxial tensile strain ε_{11} applied to the piezoresistor is directly related to the in-plane uniaxial tensile stress ε_{11} . The order of $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11}$ for single-crystal silicon is $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11} \sim 1/S_{11} \sim 10^{-12}$ (1/Pa). On the other hand, the orders of the piezoresistance tensor components Π_{11} , Π_{12} , and Π_{44} for single-crystal silicon are Π_{11} , Π_{12} , and $\Pi_{44} \sim 10^{-9}$ (1/Pa), respectively. Therefore, the effect of the relative resistance change due to elastic deformation can be neglected for single-crystal silicon.

3. Piezoresistance Measurement

A piezoresistive rosette stress gauge consisting of seven p-type piezoresistors was prepared on an n-type (100) silicon substrate. Each piezoresistor had a length of 100 μ m, a width of 10 μ m, and a depth of 2 μ m. The shape of the piezoresistive rosette stress gauge formed a right angle. The longitudinal directions of the two end piezoresistors coincided with the <110> crystallographic orientation. The right angle was divided into 15° steps from the end as shown



Fig. 3. (Color online) Graphical representations of the relative resistance change $(2\varepsilon_{11} - \varepsilon_{pp})/\sigma_{11}$ due to the inplane uniaxial tension σ_{11} with respect to the arbitrary crystallographic orientation in {100}, {110}, and {111} planes of the single-crystal silicon (unit: ×10⁻¹¹ Pa⁻¹).

in Fig. 4. The piezoresistive rosette stress gauge was fabricated by a combination of twostep thermal diffusion and ultraviolet lithography. The sheet resistance of the p-type silicon diffusion layer was 52.6 Ω/\Box and the surface carrier concentration was approximately 10^{18} cm⁻³. A rectangular microbeam was cut from the n-type (100) silicon substrate and used to remotely apply the uniform tensile stress σ_0 along the <110> direction to the piezoresistive rosette stress gauge via a simple four-point bending system (Fig. 5).

As previously mentioned in the discussion of Eq. (16), the relative resistance change in a piezoresistor in which the directions of the current density and electrical field are both parallel to an arbitrary x'_1 direction in the crystallographic plane (X_1X_2 -plane) is

$$\frac{\Delta R'_{11}}{R_0} \approx \frac{1}{3} (\Pi_{11} + 2\Pi_{12}) (\sigma_{11} + \sigma_{22}) - \frac{1}{3} (\Pi_{11} - \Pi_{12}) (a_{11}^2 + a_{21}^2) (\sigma_{11} + \sigma_{22}) + (\Pi_{11} - \Pi_{12}) (a_{11}^2 \sigma_{11} + a_{21}^2 \sigma_{22}) + 2\Pi_{44} a_{11} a_{21} \sigma_{12}.$$
(21)

Therefore, the response of the piezoresistive rosette stress gauge depends on the three plane



Fig. 4. (Color online) Schematic of the piezoresistive rosette stress gauge that consists of seven p-type piezoresistors on the n-type (100) silicon substrate.



Fig. 5. (Color online) Rectangular microbeam of the n-type (100) silicon substrate used to apply the uniform remote tensile stress σ_0 along <110> direction to the piezoresistive rosette stress gauge via a simple four-point bending.

stress components σ_{11} , σ_{22} , and σ_{12} applied to the principal crystallographic axis in the {100} plane. It is straightforward to derive Eq. (14) in Ref. 16 as a special case of Eq. (21).

Figure 6 shows the relationship between the transformation of the stress component and the crystallographic orientation subjected to uniform remote uniaxial tensile stress σ_0 along <110> in the {100} plane. The constitutive equation for this experiment can be rewritten from Eq. (21) with Euler angles ($\psi = 0, \theta = 0$) and direction cosines $a_{11} = \cos\phi$ and $a_{21} = -\sin\phi$.

$$\frac{\Delta R'_{11}}{R_0} \cong \frac{\Pi_{11} + 2\Pi_{12}}{3} \sigma_0 - \left(\frac{\Pi_{11} - \Pi_{12}}{6} - \frac{\Pi_{44}}{2}\right) \sigma_0 \sin 2\phi , \qquad (22)$$

where
$$\left(\frac{\Delta R'_{11}}{R_0}\right)_{hydrostatic} \approx \frac{\Pi_{11} + 2\Pi_{12}}{3} \sigma_0 \text{ and } \left(\frac{\Delta R'_{11}}{R_0}\right)_{deviatoric} \approx -\left(\frac{\Pi_{11} - \Pi_{12}}{6} - \frac{\Pi_{44}}{2}\right) \sigma_0 \sin 2\phi$$
,
and $-\frac{\pi}{4} \leq \phi \leq \frac{\pi}{4}$, $\phi = \pm \frac{\pi}{4}$ coincides with <110>, and $\phi = 0$ coincides with <100> as shown in
Fig. 6. If we perform the superposition and replacement of the remote stress as $\sigma_{11} = \sigma_{22} = \frac{\sigma_0}{2}$
and $\sigma_{12} = +\frac{\sigma_0}{2}$, then the alternative derivation of Eq. (22) from Eq. (21) is straightforward.

A semiconductor parameter analyzer (HP4155A) was used to measure the resistance change in the piezoresistive rosette stress gauge. Figure 7 shows a comparison of the normalized theoretical equation $\frac{\Delta R'_{11}}{\left|\Delta R'_{11}\right|_{max}}$ based on Eq. (22) and the experimental results. The theoretical

equation was in good agreement with the experimental values. Thus, the part of the proposed theory was experimentally verified.



Fig. 6. Relationship between the stress component transformation and the crystallographic orientation under the uniform remote tensile stress σ_0 along <110> direction in {100} plane depicted in Fig. 4.



Fig. 7. Comparison of the normalized theoretical equation of $\frac{\Delta R'_{11}}{\left|\Delta R'_{11}\right|_{max}}$ and the experimental results.

4. Physical Interpretation of PT Theory Based on the New Piezoresistance Tensor Equation

The validity of the proposed theory was verified by experimental evidence in the previous section. Here, we demonstrate that the design of a piezoresistor derived by using PT theory can be reproduced as a special case of our piezoresistance equation. We primarily discuss a piezoresistor fabricated by the planar diffusion technique on the surface of bulk single-crystal silicon and a piezoresistor fabricated on silicon-on-insulator (SOI) substrates as described in the previous section. We assume that the in-plane normal and shear stresses are faithfully transmitted to the piezoresistors as assumed by Pfann and Thurston.⁽⁸⁾

4.1 Tensor equation for piezoresistor responding only to specified stress components

The basic concept of the PT theory is to form a piezoresistor that responds only to specified stress components. Regarding this point, the PT theory provides no physical basis to find a combination of appropriate crystallographic orientations that exhibit sensitivity to the specified stress components. We start from Eq. (10) to provide a new physical basis in a manner unified with the PT theory.

$$\frac{\Delta \rho_{\alpha \alpha}}{\rho_0} = \frac{1}{3} (\Pi_{11} + 2\Pi_{12}) \sigma_{kk} + \Pi_{44} \left(\sigma_{\alpha \alpha} - \frac{1}{3} \sigma_{kk} \right) + (\Pi_{11} - \Pi_{12} - \Pi_{44}) L_{\alpha \alpha ij} \left(\sigma_{ij} - \frac{1}{3} \sigma_{kk} \delta_{ij} \right),$$
(23)

Note that the tensor summation convention does not apply to the Greek indices. Equation (23) corresponds to the configuration of a piezoresistor subjected to multiaxial stress, where the electrical field and current density vectors are both parallel to the x_{α} direction. By setting $L_{\alpha\alpha 12} = L_{\alpha\alpha 21} = 0$, $L_{\alpha\alpha 23} = L_{\alpha\alpha 32} = 0$, and $L_{\alpha\alpha 31} = L_{\alpha\alpha 13} = 0$, the crystallographic orientations for which the piezoresistor does not respond to the shear stress components can be obtained from Eq. (23). The hydrostatic part of Eq. (23), i.e., $\frac{1}{3}(\Pi_{11} + 2\Pi_{12})\sigma_{kk}$, is scalar-invariant and responds to the first stress invariant regardless of the crystallographic orientation. Therefore, making a piezoresistor unresponsive to specified stress components is equivalent to finding an appropriate form of the deviatoric part of Eq. (23) that can cancel the specified stress components appearing in the hydrostatic part of Eq. (23). If we design a piezoresistor that does not respond to the stress component $\sigma_{\beta\beta}$, then the general procedure is to find a combination of appropriate crystallographic orientations $L_{\alpha\alpha\beta\beta}$ that cancel the stress component of $\sigma_{\beta\beta}$ in the hydrostatic part (see Appendix B), where $L_{\alpha\alpha\beta\beta}$ is given by

$$L_{\alpha\alpha\beta\beta} = -\frac{\Pi_{12}}{\Pi_{11} - \Pi_{12} - \Pi_{44}} \text{ for } \alpha \neq \beta,$$
(24)

$$L_{\alpha\alpha\beta\beta} = -\frac{\Pi_{12} + \Pi_{44}}{\Pi_{11} - \Pi_{12} - \Pi_{44}} \text{ for } \alpha = \beta.$$
(25)

4.2 Tensor equation for piezoresistor insensitive to stress orientation

The removal of the third piezoresistor from the three-piezoresistor configuration results in a two-piezoresistor configuration. This configuration is a special case of the series-connected three-piezoresistor configuration represented by Eq. (13) (Fig. 2), which is scalar-invariant with respect to the coordinate transformation. Equation (23) leads to

$$\frac{\Delta\rho_{33}}{\rho_0} = \Pi_{12} \left(\sigma_{11} + \sigma_{22} \right) + \left(\Pi_{11} - \Pi_{12} - \Pi_{44} \right) \left(L_{3311} \sigma_{11} + L_{3322} \sigma_{22} \right), \tag{26}$$

which corresponds to the configuration of a piezoresistor subjected to in-plane biaxial normal stress with the electrical field and current density vectors both parallel to the plane normal direction x_{α} . Therefore, the general equation corresponding to the two-piezoresistor configuration is

$$\frac{\Delta\rho_{mm}}{\rho_0} - \frac{\Delta\rho_{33}}{\rho_0} = (\Pi_{11} + \Pi_{12})(\sigma_{11} + \sigma_{22}) - (\Pi_{11} - \Pi_{12} - \Pi_{44})(L_{3311}\sigma_{11} + L_{3322}\sigma_{22}).$$
(27)

Finding a combination of crystallographic orientations of L_{3311} and L_{3322} that is scalar-valued corresponds to finding the conditions under which the piezoresistor is insensitive to the in-plane biaxial stress orientation.

From the viewpoint of tensor calculus, these considerations provide a state-of-the-art physical basis for and insight into the classical PT theory.

4.3 Piezoresistor responding only to transverse normal stress

In Sects. 4.3 and 4.4, we apply the concept described in Sect. 4.1. We consider a piezoresistor subject to biaxial normal and shear stresses as shown in Fig. 8. The relative resistance change for the current density and electrical field in the x_3 direction is given by Eq. (10), which neglects the dimensional change due to the elastic deformation. If we consider the plane stress in the (x_1, x_2) plane, Eqs. (10) and (23) lead to

$$\frac{\Delta\rho_{33}}{\rho_0} = (\Pi_{11} + 2\Pi_{12} - \Pi_{44})\sigma + (\Pi_{11} - \Pi_{12} - \Pi_{44})[L_{3311}(\sigma_{11} - \sigma) + L_{3322}(\sigma_{22} - \sigma) - L_{3333}\sigma + 2L_{3312}\sigma_{12}].$$
(28)



Fig. 8. Piezoresistor subjected to biaxial normal and shear stresses [relative resistance change for the current density and electrical field in the x_3 direction with the plane stress in the (x_1, x_2) plane].

The response depends on the three plane stress components σ_{11} , σ_{22} , and σ_{12} in the (x_1, x_2) plane. As a particular case, the piezoresistor responds only to the biaxial normal stresses σ_{11} and σ_{22} in the x_1 and x_2 directions, respectively, if the x_1 and x_3 directions are <110> and the x_2 direction is <100>. In this case, the three Euler angles (σ , θ , ϕ) are $\left(\psi = 0, \theta = \frac{\pi}{4}, \phi = 0\right)$. Then, Eq. (3) becomes Eq. (29).

The fourth-rank tensor components L_{ijkl} obtained from Eq. (10) are $L_{3311} = L_{3333} = \frac{1}{2}$ and $L_{3311} = L_{3312} = 0$. Indeed, the piezoresistor does not respond to the in-plane shear stress component σ_{12} because $L_{3312} = 0$. Thus, Eq. (26) leads to

$$\frac{\Delta \rho_{33}}{\rho_0} = \frac{1}{2} \left(\Pi_{11} + \Pi_{12} - \Pi_{44} \right) \sigma_{11} + \Pi_{12} \sigma_{22} \,. \tag{30}$$

It is evident that Eq. (30) coincides with Eq. (11) of Pfann and Thurston.⁽⁸⁾

Furthermore, the orthogonal orientations insensitive to both σ_{22} and σ_{12} can be found by choosing the Euler angles as $\left(\psi = \frac{\pi}{2}, \theta = \frac{\pi}{2} + \alpha, \phi = \frac{\pi}{4}\right)$. Then, Eq. (3) becomes Eq. (31).

$$X_{1} = \frac{x_{1}}{\sqrt{2}} - \frac{x_{2}}{\sqrt{2}} - \frac{x_{3}}{\sqrt{2}}$$

$$X_{1} = -\frac{1}{\sqrt{2}} - \frac{\sin \alpha}{\sqrt{2}} - \frac{\cos \alpha}{\sqrt{2}}$$

$$X_{2} = -\frac{1}{\sqrt{2}} - \frac{\sin \alpha}{\sqrt{2}} - \frac{\cos \alpha}{\sqrt{2}}$$

$$X_{3} = 0 - \cos \alpha - \sin \alpha$$
(31)

The fourth-rank tensor components L_{ijkl} obtained from Eq. (31) are $L_{3311} = \frac{1}{2}\cos^2 \alpha$, $L_{3322} = \frac{3}{2}\cos^2 \alpha \sin^2 \alpha$, $L_{3312} = 0$, and $L_{3333} = \frac{1}{2}(\cos^4 \alpha + \sin^4 \alpha)$. Therefore, Eq. (28) leads to

$$\frac{\Delta \rho_{33}}{\rho_0} = \Pi_{12} \left(1 - \frac{\cos^2 \alpha}{2C} \right) \sigma_{11} + \Pi_{12} \left(1 - \frac{3\sin^2 2\alpha}{8C} \right) \sigma_{22} \,. \tag{32}$$

where $C = -\frac{\Pi_{12}}{\Pi_{11} + \Pi_{12} - \Pi_{44}}$.

Equation (32) is identically insensitive to σ_{12} . The combination of Eqs. (23) and (24) leads to a physical basis for the problem that a piezoresistor only responds to σ_{11} because L_{3322} satisfies Eq. (24), i.e., $L_{3322} = \frac{3}{2}\cos^2 \alpha \sin^2 \alpha = C$. Indeed, if we choose $\sin^2 \alpha = \frac{8C}{3}$, then Eq. (32) is insensitive to σ_{22} . It is evident that Eq. (32) coincides with Eq. (13) of Pfann and Thurston.⁽⁸⁾

4.4 Piezoresistor having zero transverse normal stress sensitivity

The relative resistance change for the current density and electrical field in the x_3 direction is given by Eqs. (10) and (23), which neglect the dimensional change due to elastic deformation. If we consider the plane stress in the (x_1 , x_3) plane shown in Fig. 9, Eqs. (10) and (23) lead to

$$\frac{\Delta \rho_{33}}{\rho_0} = (\Pi_{11} + 2\Pi_{12} - \Pi_{44})\sigma + \Pi_{44}\sigma_{33} + (\Pi_{11} - \Pi_{12} - \Pi_{44})[L_{3311}(\sigma_{11} - \sigma) + L_{3322}\sigma - L_{3333}(\sigma_{33} - \sigma) + 2L_{3313}\sigma_{13}].$$
(33)



Fig. 9. Piezoresistor subjected to biaxial normal and shear stresses [relative resistance change for the current density and electrical field in the x_3 direction with the plane stress in the (x_1, x_3) plane].

The orthogonal orientations insensitive to both σ_{33} and σ_{13} can be found by choosing the Euler angles as $\left(\psi, \theta = \frac{\pi}{4}, \phi = 0\right)$. Then, Eq. (3) becomes Eq. (34).

$$X_{1} \quad X_{2} \quad X_{3}$$

$$X_{1} \quad \frac{\cos\psi}{\sqrt{2}} \quad \sin\psi \quad -\frac{\cos\psi}{\sqrt{2}}$$

$$X_{2} \quad -\frac{\sin\psi}{\sqrt{2}} \quad \cos\psi \quad \frac{\sin\psi}{\sqrt{2}}$$

$$X_{3} \quad \frac{1}{\sqrt{2}} \quad 0 \quad \frac{1}{\sqrt{2}}$$
(34)

The angle ψ is an arbitrary rotation around the x₃ axis perpendicular to the {110} plane. The fourth-rank tensor components L_{ijkl} obtained from Eq. (34) are $L_{3313} = 0$, $L_{3311} = \frac{1}{2}\cos^2\psi$, $L_{3322} = \frac{1}{2}\sin^2\psi$, and $L_{3333} = \frac{1}{2}$. Indeed, the piezoresistor does not respond to the in-plane shear stress component σ_{13} because $L_{3313} = 0$. Equation (33) is reduced to

$$\frac{\Delta \rho_{33}}{\rho_0} = \Pi_{12} \left(1 - \frac{1}{6C} \right) \sigma_{33} + \Pi_{12} \left(1 - \frac{\cos^2 \psi}{2C} \right) \sigma_{11}, \tag{35}$$

where $C = -\frac{\Pi_{12}}{\Pi_{11} - \Pi_{12} - \Pi_{44}}$.

Equation (35) is identically insensitive to σ_{13} . The combination of Eqs. (23) and (24) leads to a physical basis for the problem that a piezoresistor only responds to σ_{33} because L_{3311} satisfies Eq. (24), i.e., $L_{3311} = \frac{1}{2}\cos^2 \psi = C$. Indeed, if we choose $\cos^2 \psi = 2C$, then Eq. (35) is insensitive to σ_{11} . Thus, the piezoresistor responds only to the longitudinal normal stress σ_{33} and has zero transverse normal stress sensitivity. It is evident that Eq. (35) coincides with Eq. (20) of Pfann and Thurston.⁽⁸⁾

4.5 Piezoresistor insensitive to stress orientation

In this section, we apply the concept described in Sect. 4.2. Figure 10 shows a piezoresistor in the form of an ell with two in-plane perpendicular arms, where x_1 and x_2 denote the directions of the arms. If we consider the plane stresses σ_{11} , σ_{22} , and σ_{12} in the (x_1, x_2) plane, then Eq. (10) leads to



Fig. 10. Piezoresistor made in the form of an ell with the in-plane two perpendicular arms: (a) $x_3 //\{100\}$, (b) $x_3 //\{111\}$, x_1 and x_2 denote the directions of the arms.

$$\frac{\Delta \rho_{11}}{\rho_0} + \frac{\Delta \rho_{22}}{\rho_0} = \frac{2}{3} (\Pi_{11} + 2\Pi_{12} + \Pi_{44}) (\sigma_{11} + \sigma_{22}) - \frac{(\Pi_{11} - \Pi_{12} - \Pi_{44})}{3} (L_{1133} + L_{2233}) (\sigma_{11} + \sigma_{22}) + \frac{(\Pi_{11} - \Pi_{12} - \Pi_{44})}{3} [(L_{1111} + L_{1122}) (2\sigma_{11} - \sigma_{22}) + (L_{1122} + L_{2222}) (2\sigma_{22} - \sigma_{11})].$$
(36)

A piezoresistor insensitive to the orientations of σ_{11} and σ_{22} can be obtained from Eq. (10) by choosing the Euler angles as ($\psi = 0$, $\theta = 0$, ϕ). Then, Eq. (3) becomes Eq. (37).

The angle ϕ is an arbitrary rotation around the x_3 axis perpendicular to the {100} plane. The fourth-rank tensor components L_{ijkl} obtained from Eq. (37) are $L_{1111} = L_{2222} = \cos^4 \phi + \sin^4 \phi$, $L_{1122} = 2\cos^2 \phi \sin^2 \phi$, and $L_{1133} = L_{2233} = 0$. Equation (10) is reduced to

$$\frac{\Delta\rho_{11}}{\rho_0} + \frac{\Delta\rho_{22}}{\rho_0} = \left(\Pi_{11} + \Pi_{12}\right) \left(\sigma_{11} + \sigma_{22}\right).$$
(38)

Equation (38) is identically insensitive to the orientations of σ_{11} and σ_{22} . It is evident that Eq. (38) coincides with Eq. (23) of Pfann and Thurston.⁽⁸⁾ An alternative solution of Eq. (38) is straightforward and is obtained from Eq. (27) as

$$\frac{\Delta \rho_{mm}}{\rho_0} - \frac{\Delta \rho_{33}}{\rho_0} = \left(\Pi_{11} + \Pi_{12}\right) \left(\sigma_{11} + \sigma_{22}\right). \tag{39}$$

An alternative piezoresistor insensitive to the orientations of σ_{11} and σ_{22} can be obtained from Eq. (27) by choosing the Euler angles as $\left(\psi, \theta = \cos^{-1}\frac{1}{\sqrt{3}}, \phi = \cos^{-1}\frac{1}{\sqrt{2}}\right)$. Then, Eq. (3) becomes Eq. (40).

$$X_{1} = \frac{x_{2}}{\sqrt{6}} - \frac{x_{3}}{\sqrt{2}} = \frac{x_{3}}{\sqrt{6}} - \frac{x_{3}}{\sqrt{2}} = \frac{x_{3}}{\sqrt{6}} - \frac{x_{3}}{\sqrt{6}$$

The angle ψ is an arbitrary rotation around the x_3 axis perpendicular to the {111} plane as shown in Fig. 10(b). The fourth-rank tensor components L_{ijkl} obtained from Eq. (40) are $L_{1111} = L_{1122} = \frac{1}{2}$, $L_{2222} = \frac{1}{6}$, and $L_{1133} = L_{2233} = L_{3333} = \frac{2}{3}$. Equation (10) leads to

$$\frac{\Delta\rho_{11}}{\rho_0} + \frac{\Delta\rho_{22}}{\rho_0} = \frac{1}{3} \left(2\Pi_{11} + 4\Pi_{12} + \Pi_{44} \right) \left(\sigma_{11} + \sigma_{22} \right). \tag{41}$$

Equation (41) is identically insensitive to the orientations of σ_{11} and σ_{22} . It is evident that Eq. (41) coincides with Eq. (24) of Pfann and Thurston.⁽⁸⁾ Similarly to Eq. (39), an alternative solution of Eq. (41) can be easily obtained from Eq. (27).

5. Conclusions

We have derived a single piezoresistance tensor equation that clearly indicates the physical role of the state of multiaxial stress in the cubic crystal anisotropy of piezoresistance. The piezoresistance tensor equation for cubic crystal symmetry can be expressed in terms of the three independent components of the principal piezoresistance tensor, the isotropic and deviatoric stress tensors, and the fourth-rank coordinate transformation tensor. To demonstrate the validity of the proposed tensor equation, an experiment on the single-crystal silicon piezoresistance stress gauge subjected to multiaxial stress was carried out. Furthermore, the proposed piezoresistance tensor equation can give a physical basis for the typical single-crystal silicon piezoresistive stress transducers derived by Pfann and Thurston.

Acknowledgments

This work was supported by JSPS KAKENHI Grant Number JP16H03819.

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Appendix

A. Isotropic and deviatoric fourth-rank tensors⁽¹⁷⁾

Components of the isotropic tensor are invariant with respect to the coordinate transformation. We can make an isotropic fourth-rank tensor from an arbitrary fourth-rank tensor with the symmetry of $T_{ijkl} = T_{jikl} = T_{ijlk}$,

$$\left(T_{ijkl}\right)_{isotropic} = T_1 \delta_{ij} \delta_{kl} + 2T_2 I_{ijkl} , \qquad (A1)$$

where

$$T_{1} = \frac{1}{15} \left(2T_{ppqq} - T_{pqpq} \right),$$
(A2)

$$T_2 = \frac{1}{30} \Big(3T_{pqpq} - T_{ppqq} \Big).$$
(A3)

A deviatoric part of the tensor can be obtained by subtracting the isotropic part from the original tensor.

$$\left(T_{ijkl}\right)_{deviatoric} = T_{ijkl} - \left(T_{ijkl}\right)_{isotropic} \tag{A4}$$

Substituting Eq. (4), i.e., $\pi_{ijkl} = \hat{\Pi}_1 \delta_{ij} \delta_{kl} + 2\hat{\Pi}_2 I_{ijkl} + \hat{\Pi}_3 L_{ijkl}$ into Eqs. (A2) and (A3), we obtain

$$\pi_{ppqq} = \hat{\Pi}_1 \delta_{pp} \delta_{qq} + 2\hat{\Pi}_2 I_{ppqq} + \hat{\Pi}_3 L_{ppqq} = 9\hat{\Pi}_1 + 6\hat{\Pi}_2 + 3\hat{\Pi}_3, \tag{A5}$$

$$\pi_{pqpq} = \hat{\Pi}_1 \delta_{pq} \delta_{pq} + 2\hat{\Pi}_2 I_{pqpq} + \hat{\Pi}_3 L_{pqpq} = 3\hat{\Pi}_1 + 12\hat{\Pi}_2 + 3\hat{\Pi}_3,$$
(A6)

$$T_1 = \hat{\Pi}_1 + \frac{1}{5}\hat{\Pi}_3 \text{ and } T_2 = \hat{\Pi}_2 + \frac{1}{5}\hat{\Pi}_3.$$
 (A7)

Note that $L_{ppqq} = L_{pqpq} \equiv \sum_{L=1}^{3} (a_{Lp})^2 (a_{Lq})^2 = 3.$

Thus, Eqs. (A1) and (A4) can be rewritten by using Eqs. (A2), (A3), (A5), (A6), and (A7),

$$\left(\pi_{ijkl}\right)_{isotropic} = \left(\hat{\Pi}_1 + \frac{1}{5}\hat{\Pi}_3\right) \delta_{ij} \delta_{kl} + 2\left(\Pi_2 + \frac{1}{5}\Pi_3\right) I_{ijkl} ,$$

$$\left(\pi_{ijkl}\right)_{deviatoric} = \hat{\Pi}_3 \left[L_{ijkl} - \frac{1}{5}\left(\delta_{ij}\delta_{kl} + 2I_{ijkl}\right)\right].$$
[Eq. (6)]

B. Derivations of Eqs. (24) and (25)

Here, the tensor summation convention does not apply to the Greek indices. The piezoresistance in the cubic single crystal subjected to multiaxial stress with the electrical field and current density vectors both parallel to the x_{α} direction is given as

$$\frac{\Delta \rho_{\alpha \alpha}}{\rho_0} = \frac{1}{3} (\Pi_{11} + 2\Pi_{12}) \sigma_{kk} + \Pi_{44} \left(\sigma_{\alpha \alpha} - \frac{1}{3} \sigma_{kk} \right) \\ + (\Pi_{11} - \Pi_{12} - \Pi_{44}) L_{\alpha \alpha i j} \left(\sigma_{i j} - \frac{1}{3} \sigma_{kk} \delta_{i j} \right), \qquad [Eq. (23)]$$

where the deviatoric part of Eq. (23) is

$$\Pi_{44} \left[\sigma_{\alpha\alpha} - \frac{1}{3} (\sigma_{11} + \sigma_{22} + \sigma_{33}) \right] + (\Pi_{11} - \Pi_{12} - \Pi_{44}) (L_{\alpha\alpha 11} \sigma_{11} + L_{\alpha\alpha 22} \sigma_{22} + L_{\alpha\alpha 33} \sigma_{33} + 2L_{\alpha\alpha 12} \sigma_{12} + 2L_{\alpha\alpha 23} \sigma_{23} + 2L_{\alpha\alpha 31} \sigma_{31}) - \frac{1}{3} (\Pi_{11} - \Pi_{12} - \Pi_{44}) (\sigma_{11} + \sigma_{22} + \sigma_{33}),$$
(B1)

and the terms related to the normal stress component $\sigma_{\beta\beta}$ are

$$-\frac{1}{3} \Pi_{44} \sigma_{\beta\beta} + \left(\Pi_{11} - \Pi_{12} - \Pi_{44}\right) \left(L_{\alpha\alpha\beta\beta} - \frac{1}{3}\right) \sigma_{\beta\beta} \quad \text{for } \alpha \neq \beta, \tag{B2}$$

$$\frac{2}{3}\Pi_{44}\sigma_{\beta\beta} + \left(\Pi_{11} - \Pi_{12} - \Pi_{44}\right)\left(L_{\alpha\alpha\beta\beta} - \frac{1}{3}\right)\sigma_{\beta\beta} \quad \text{for } \alpha = \beta.$$
(B3)

The hydrostatic part of Eq. (23) is scalar-invariant and always responds to hydrostatic stress regardless of the crystallographic orientation.

$$\frac{1}{3} (\Pi_{11} + 2\Pi_{12}) (\sigma_{11} + \sigma_{22} + \sigma_{33})$$
(B4)

Therefore, making a piezoresistor unresponsive to the normal stress component $\sigma_{\beta\beta}$ corresponds to cancelling $\sigma_{\beta\beta}$ appearing in Eq. (B4), which is derived from Eqs. (B2) and (B3):

$$-\frac{1}{3} \Pi_{44} \sigma_{\beta\beta} + (\Pi_{11} - \Pi_{12} - \Pi_{44}) \left(L_{\alpha\alpha\beta\beta} - \frac{1}{3} \right) \sigma_{\beta\beta} = -\frac{1}{3} (\Pi_{11} + 2\Pi_{12}) \sigma_{\beta\beta} \quad \text{for } \alpha \neq \beta, \quad (B5)$$

$$\frac{2}{3}\Pi_{44}\sigma_{\beta\beta} + (\Pi_{11} - \Pi_{12} - \Pi_{44}) \left(L_{\alpha\alpha\beta\beta} - \frac{1}{3} \right) \sigma_{\beta\beta} = -\frac{1}{3} (\Pi_{11} + 2\Pi_{12}) \sigma_{\beta\beta} \quad \text{for } \alpha = \beta.$$
(B6)

Thus, we obtain the following set of crystallographic orientations that satisfy Eqs. (B5) and (B6):

$$L_{\alpha\alpha\beta\beta} = -\frac{\Pi_{12}}{\Pi_{11} - \Pi_{12} - \Pi_{44}} \text{ for } \alpha \neq \beta, \qquad [Eq. (24)]$$

$$L_{\alpha\alpha\beta\beta} = -\frac{\Pi_{12} + \Pi_{44}}{\Pi_{11} - \Pi_{12} - \Pi_{44}} \text{ for } \alpha = \beta.$$
 [Eq. (25)]

About the Authors



Taeko Ando received her B.E. degree in aerospace engineering and her M.S. and Ph.D. degrees in microsystem engineering from Nagoya University, Japan, in 1996, 1999, and 2001, respectively. From 2001 to 2008, she was an assistant professor and from 2008 to 2009, a senior lecturer at Nagoya University, Japan. Since 2009, she has been an associate professor at Ritsumeikan University. Her research interests are in the physical properties of MEMS material in a micro/nanoscale.



Toshiyuki Toriyama received his Ph.D. degree from Kyushu University, Japan, in 1994. Since 2004, he has been a professor at Ritsumeikan University, Japan. His research interests are in piezoresistance materials and microscale turbomachinery.